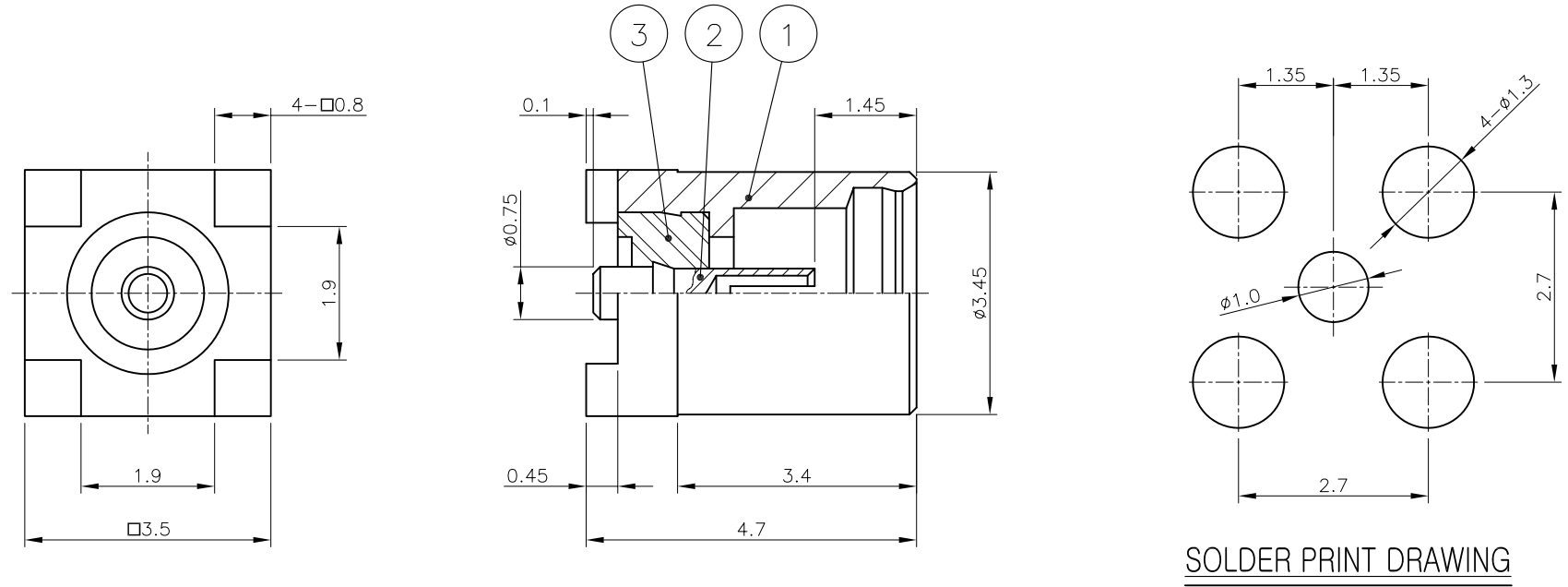


REVISION		
REV	DESCRIPTION	DATE
IR	Initial Registration	2009. 10. 14.



SOLDER PRINT DRAWING

* NOTE.

1. BODY : 하지Ni 5 μm 이상 / Gold 0.06 μm 이상
2. CONTACT : 하지Ni 5 μm 이상 / Gold 1.27 μm 이상

3	INSULATOR	1	TEFLON		DIN01671-N/1
2	CONTACT	1	BeCu	Note.2	DCT02117-5/1
1	BODY	1	MBsBD	Note.1	DBD02615-5/1
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal	DATE 2009. 10. 14.		 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017
	Angle	APPROVED BY	J.H.YOUN	
MATERIAL		CHECKED BY	I.C.KIM	TITLE MMCX50-J-4R-R SMT
		DRAWN BY	E.H.KIM	
FINISH		SCALE	UNIT	DWG NO. CN02479-7/1 REVISION I R SHEET 1 of 1
		10/1	mm	